

**Updated Notice on Conclusion of Absorption-type Company
Split Agreements with In-house Companies**

TOKYO–Toshiba Corporation (“the Company”) announced on May 30th, in “Notice on Conclusion of Absorption-type Company Split Agreements in Respect of In-house Companies,” the conclusion of absorption-type company split agreements (“the Company Split Agreements”) in respect of its Infrastructure Systems & Solutions Company (“ISS”), Storage & Electronic Devices Solutions Company (“SDS”) and Industrial ICT Solutions Company (excluding Information Systems Division and the R&D group reporting to corporate in the Software & AI Technology Center, “INS”), and hereby announces information on matters that remained undecided at the time of that announcement.

Underlined sections below indicate matters that were undecided at the time of the May 30, 2017 announcement. Some disclosure items and details are omitted since the Company Splits are between the Company and its wholly-owned subsidiaries (“the Succeeding Companies”).

6. Overview of the succeeding company after Company Split #1 (After July 1, 2017)

Name	Toshiba Infrastructure Systems & Solutions Corporation
Name and Title of Representative	<u>Shinichiro Akiba, President & CEO</u>

6. Overview of the succeeding company after Company Split #2 (After July 1, 2017)

Name	Toshiba Electronic Devices & Storage Corporation
Name and Title of Representative	<u>Hiroshi Fukuchi, President & CEO</u>

6. Overview of the succeeding company after Company Split #3 (After July 1, 2017)

Name	Toshiba Digital Solutions Corporation
Name and Title of Representative	<u>Hironobu Nishikori, President & CEO</u>

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